

M.2 (P80)

4TG2-P Series

Customer:	
Customer	
Part Number:	
Innodisk	
Part Number:	
Innodisk	
Model Name:	
Date:	

Innodisk	Customer
Approver	Approver

Total Solution For Industrial Flash Storage



Table of contents

1. PRODUCT OVERVIEW	8
1.1 Introduction of Innodisk M.2 (P80) 4TG2-P	8
1.2 PRODUCT MODELS	
1.3 PCIE INTERFACE	9
2. PRODUCT SPECIFICATIONS	10
2.1 CAPACITY AND DEVICE PARAMETERS	10
2.2 PERFORMANCE	10
2.3 ELECTRICAL SPECIFICATIONS	11
2.3.1 Power Requirement	
2.3.2 Power Consumption	
2.4 Environmental Specifications	11
2.4.1 Temperature Ranges	11
2.4.2 Humidity	11
2.4.3 Shock and Vibration	12
2.4.4 Mean Time between Failures (MTBF)	12
2.5 CE AND FCC COMPATIBILITY	12
2.6 Rohs Compliance	12
2.8 Transfer Mode	13
2.9 PIN ASSIGNMENT	14
2.10 Mechanical Dimensions	15
2.11 ASSEMBLY WEIGHT	16
2.12 SEEK TIME	16
2.13 NAND FLASH MEMORY	16
3. THEORY OF OPERATION	17
3.1 Overview	17
3.2 PCIE GEN. 4 x4 CONTROLLER	17
3.3 ERROR DETECTION AND CORRECTION	17
3.4 WEAR-LEVELING	18
3.5 BAD BLOCKS MANAGEMENT	18
3.6 IDATA GUARD	18
3.7 GARBAGE COLLECTION/TRIM	18
3.8 THERMAL MANAGEMENT	18
3.9 THERMAL THROTTLING	19
3.10 DIE RAID	19
3.11 SLC CACHE	19
3.12 ICELL TECHNOLOGY	19



4. INSTALLATION REQUIREMENTS	20
4.1 M.2 (P80) 4TG2-P PIN DIRECTIONS	20
4.2 ELECTRICAL CONNECTIONS FOR M.2 (P80) 4TG2-P	20
4.3 DEVICE DRIVE	20
5. SMART / HEALTH INFORMATION	21
5.1 GET LOG PAGE (LOG IDENTIFIER 02H)	21
6. PART NUMBER RULE	25



Features:

- PCIe Gen.4 x 4, NVMe SSD
- Kioxia 3D TLC NAND
- Standard & Wide temperature
- iCell Feature
- iDataguard
- Thermal Throttling Management
- 256-bit AES hardware-based encryption
- Hybrid Write Mode with SLC Cache Enable

Performance:

- Sequential Read up to 6,950 MB/s
- Sequential Write up to 4,700 MB/s

Power Requirements:

Input Voltage:	3.3V±5%	
Max Operating	9.9W	
Wattage (R/W):		
Idle Wattage:	1.3W	

Reliability:

Canacity	TBW	DWPD	
Capacity	(Client)		
512GB	768	1.61	
1TB	1827	1.91	
2TB	4574	2.39	

Data Retention	10 Year
Warranty	3 Years

For warranty details, please refer to:

https://www.innodisk.com/en/support_and_service/warranty



REVISION HISTORY

Revision	Description	Date
V1.0	First Release	Dec., 2022
V1.1	Revise PN rule, Pin Assignment	Feb., 2023
V1.2	Add WT information	Mar, 2023
V1.3	Revise Mechanical Dimensions	Apr., 2023
V1.4	Revise SMART / Health Information	Apr., 2023
V1.5	Revise SMART / Health Information &	May, 2023
	Electrical Connections	
V1.6	Revise Mechanical Dimensions	June, 2023
V1.7	Revise Performance Noted	Nov., 2023
	Add Thermal Throttling Description	
V1.8	Update Performance	Nov., 2023
V1.9	Update Product Feature	Feb., 2024
V2.0	Update TBW	Apr., 2024
	Add ESD information	



List of Tables

Table 1: Device parameters	10
Table 2: Performance - 112 Layers 3D TLC	10
Table 3: Innodisk M.2 (P80) 4TG2-P Power Requirement	11
Table 4: Typical Power Consumption	11
Table 5: Temperature range for M.2 (P80) 4TG2-P	11
Table 6: Shock/Vibration Testing for M.2 (P80) 4TG2-P	12
Table 7: M.2 (P80) 4TG2-P MTBF	12
Table 8: M.2 (P80) 4TG2-P ESD	12
Table 9: M.2 (P80) 4TG2-P TBW	13
Table 10: Innodisk M.2 (P80) 4TG2-P Pin Assignment	14
Table 11: Innodisk M.2 (P80) 4TG2-P LED Indicator	15
Table 12: M.2 (P80) 4TG2-P SLC cache	
TABLE 13: GET LOG PAGE - SMART / HEALTH INFORMATION LOG	



List of Figures

FIGURE 1: INNODISK M.2 (P80) 4TG2-P WITH ICELL (STANDARD)	8
FIGURE 2: INNODISK M.2 (P80) 4TG2-P WITH ICELL (WIDE-TEMPERATURE)	8
FIGURE 3: INNODISK M.2 (P80) 4TG2-P WITH ICELL	15
FIGURE 4: INNODISK M.2 (P80) 4TG2-P WITH ICELL	15
FIGURE 5: INNODISK M.2 (P80) 4TG2-P WITH ICELL	16
FIGURE 6: INNODISK M.2 (P80) 4TG2-P BLOCK DIAGRAM	17
FIGURE 7: SIGNAL SEGMENT AND POWER SEGMENT	20



1. Product Overview

1.1 Introduction of Innodisk M.2 (P80) 4TG2-P

Innodisk M.2 (P80) 4TG2-P is an NVM Express SSD designed as the standard M.2 form factor with PCIe interface and 3D TLC NAND Flash. M.2 (P80) 4TG2-P supports PCIe Gen. 4 x4, and it is compliant with NVMe 1.4 providing excellent performance. M.2 (P80) 4TG2-P with heat-spreading design dissipate heat generating from IC making SSD perform more steady. M.2 (P80) 4TG2-P has Die RAID protection to reduce bad blocks happening and optimize data integrity. In addition, 4TG2-P series adopt hybrid mode which enables SLC Cache up to 3% of full disk capacity followed by TLC direct write to strike balance between burst performance and steady overall stability.

Innodisk M.2 (P80) 4TG2-P provides ultra-speed and high IOPS and offers maximum capacity up to 2TB, making the SSD optimal for server and heavy data workload applications.

CAUTION TRIM must be enabled.

TRIM enables SSD's controller to skip invalid data instead of moving. It can free up significant amount of resources, extends the lifespan of SSD by reducing erase, and write cycles on the SSD. Innodisk's handling of garbage collection along with TRIM command improves write performance on SSDs.

1.2 Product Models

Innodisk M.2 (P80) 4TG2-P is available in follow capacities within 3D TLC flash ICs.

M.2 (P80) 4TG2-P 512GB

M.2 (P80) 4TG2-P 1TB

M.2 (P80) 4TG2-P 2TB



Figure 1: Innodisk M.2 (P80) 4TG2-P with iCell (Standard)



Figure 2: Innodisk M.2 (P80) 4TG2-P with iCell (Wide-temperature)



1.3 PCIe Interface

Innodisk M.2 (P80) 4TG2-P supports PCIe Gen. 4 interface and compliant with NVMe 1.4. M.2 (P80) 4TG2-P can work under PCIe Gen. 1, Gen. 2, Gen. 3, and Gen. 4.

Most of operating system includes NVMe in-box driver now. For more information about the driver support in each OS, please visit https://nvmexpress.org/drivers/.



2. Product Specifications

2.1 Capacity and Device Parameters

M.2 (P80) 4TG2-P device parameters are shown in Table 1.

Table 1: Device parameters

Canacity	LBA	User
Capacity	LBA	Capacity(MB)
512GB	937703088	457863
1TB	1875385008	915715
2TB	3750748848	1831404

2.2 Performance

Burst Transfer Rate: 8 GB/s

Table 2: Performance - 112 Layers 3D TLC

	Temp.	Standard temperature			Wide temperature		
Capacity	Unit	512GB	1TB	2ТВ	512GB	1TB	2ТВ
Sequential**		F F00	6.050	6.650	F 000	6.050	6.650
Read (Q8T1)		5,500	6,950	6,650	5,800	6,950	6,650
Sequential**		2 250	4 100	4 700	2 200	4 150	4 700
Write (Q8T1)	MP/c	2,250	4,100	4,700	2,300	4,150	4,700
Sustained Sequential	MB/s	1 000	2.450	2 400	2.050	2 550	2.450
Read (Avg.)***		1,900	2,450	2,400	2,050	2,550	2,450
Sustained Sequential		460	760	1,050	450	870	1,500
Write (Avg.)***		460	760	1,050	450	670	1,500
4KB Random**		4E4 000	015 000	910 000	404.000	916 000	910 000
Read (Q32T16)	IODC	454,000	454,000 815,000 819,0	619,000	819,000 494,000	816,000	819,000
4KB Random**	IOPS	301,000	599,000	712,000	597,000	691,000	720,000
Write (Q32T16)		301,000	333,000	/12,000	397,000	091,000	720,000

Note: * Performance results are measured in Room Temperature with Out-of-Box devices and may vary depending on overall system setup. In addition, 4TG2-P series adopt hybrid mode which enables SLC Cache up to 3% of full disk capacity followed by TLC direct write to strike balance between burst performance and steady overall stability.

Note: ** Performance results are based on CrystalDiskMark 8.0.1 with file size 1000MB. Unit of 4KB items is I.O.P.S.

Note: *** Performance results are based on AIDA 64 v5.98 with block size 1MB of Linear Read & Write Test

Note: **** Performance may be different because ST and WT adopt different thermal solutions.

Note: *****Performance is affected by thermal throttling if device temperatures is over 75C.



2.3 Electrical Specifications

2.3.1 Power Requirement

Table 3: Innodisk M.2 (P80) 4TG2-P Power Requirement

Item	Symbol	Rating	Unit
Input voltage	V _{IN}	+3.3 DC +- 5%	V

2.3.2 Power Consumption

Table 4: Typical Power Consumption

Mode	Power Consumption (W)
Read	8.8
Write	9.9
Idle	1.3
Power-on peak	5.3

Target: 2TB M.2 (P80) 4TG2-P

Note: Current results may vary depending on system components and power circuit design

Please refer to the test report for other capacities

2.4 Environmental Specifications

2.4.1 Temperature Ranges

Table 5: Temperature range for M.2 (P80) 4TG2-P

Temperature	Range
Operating	Standard Grade: 0°C to +70°C Industrial Grade: -40°C to +85°C
Storage	-40°C to +85°C SOP

2.4.2 Humidity

Relative Humidity: 10-95%, non-condensing



2.4.3 Shock and Vibration

Table 6: Shock/Vibration Testing for M.2 (P80) 4TG2-P

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 60068-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 60068-2-27

2.4.4 Mean Time between Failures (MTBF)

Table 7 summarizes the MTBF prediction results for various M.2 (P80) 4TG2-P configurations. The analysis was performed using a RAM Commander[™] failure rate prediction.

- **Failure Rate**: The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- **Mean Time between Failures (MTBF)**: A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

Table 7: M.2 (P80) 4TG2-P MTBF

Product	Condition	MTBF (Hours)
Innodisk M.2 (P80) 4TG2-P	Telcordia SR-332 GB, 25°C	>3,000,000

2.5 CE and FCC Compatibility

M.2 (P80) 4TG2-P conforms to CE and FCC requirements.

Table 8: M.2 (P80) 4TG2-P ESD

Reliability	Reference standards
Electrostatic Discharge (ESD)	IEC 61000-4-2 ESD

2.6 RoHS Compliance

M.2 (P80) 4TG2-P is fully compliant with RoHS directive.



2.7 Reliability

Table 9: M.2 (P80) 4TG2-P TBW

3,000 P/E cycles
Support (LDPC)
Under 40°C:
10 Yeas at initial NAND Status; 1 Years at NAND Life End
S

| TBW* (Total Bytes Written) | Unit: TB

Capacity	Sequential workload	Client workload
512GB	1,364	768
1TB	2,727	1,827
2TB	5,454	4,574

^{*} Note:

- 1. Sequential: Mainly sequential write are estimated by PassMark Burnin Test v8.1 pro.
- 2. Client: Follow JESD218 Test method and JESD219A Workload, tested by ULINK. (The capacity lower than 64GB client workload is not specified in JEDEC219A, the values are estimated.)
- 3. Based on out-of-box performance.
- 4. Current TBW Values are for reference only. Actual figures will be released after MP.

2.8 Transfer Mode

M.2 (P80) 4TG2-P support following transfer mode:

PCIe Gen. 4: 8GB/s



2.9 Pin Assignment

Innodisk M.2 (P80) 4TG2-P follows standard M.2 spec, socket 3, key M PCIe-based SSD pinout. See Table 10 for M.2 (P80) 4TG2-P pin assignment.

Table 10: Innodisk M.2 (P80) 4TG2-P Pin Assignment

Signal Name	Pin #	Pin #	Signal Name
		75	GND
3.3V	74	73	GND
3.3V	72	71	GND
3.3V	70	69	NC
NC	68	67	NC
Notch	66	65	Notch
Notch	64	63	Notch
Notch	62	61	Notch
Notch	60	59	Notch
NC	58		
NC	56	57	GND
NC	54	55	REFCLKp
CLKREQ# (I/O)(0/3.3V)	52	53	REFCLKn
PERST# (I)(0/3.3V)	50	51	GND
NC	48	49	PERp0
NC	46	47	PERn0
ALERT	44	45	GND
NC(reserved for SMB_DATA)(I/O)(O/1.8V)	42	43	PETp0
NC(reserved for SMB_CLK)	40	41	PETn0
GND	38	39	GND
NC	36	37	PERp1
NC	34	35	PERn1
GND	32	33	GND
NC	30	31	PETp1
NC	28	29	PETn1
NC	26	27	GND
NC	24	25	PERp2
NC	22	23	PERn2
NC	20	21	GND
3.3V	18	19	PETp2
3.3V	16	17	PETn2
3.3V	14	15	GND
3.3V	12	13	PERp3
LED#(O)(OD)	10	11	PERn3
NC	8	9	GND
NC	6	7	PETp3
3.3V	4	5	PETn3
3.3V	2	3	GND
		1	GND



Table 11: Innodisk M.2 (P80) 4TG2-P LED indicator

LED Color	Function
Green	Power on
	Access

2.10 Mechanical Dimensions

M.2 Type 2280-D7-M with heat-spreading copper layer (Default accessory for ST)

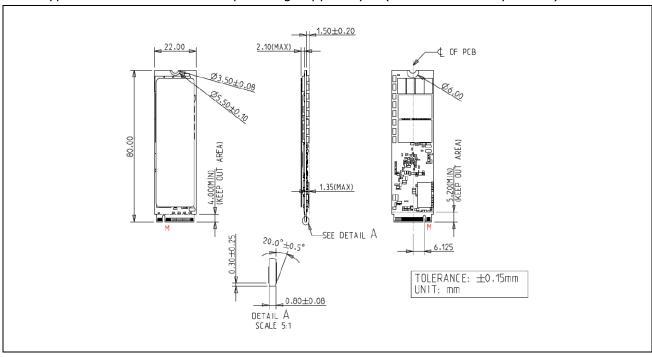


Figure 3: Innodisk M.2 (P80) 4TG2-P with iCell

M.2 Type 2280-D7-M with heatsink (Default accessory for WT)

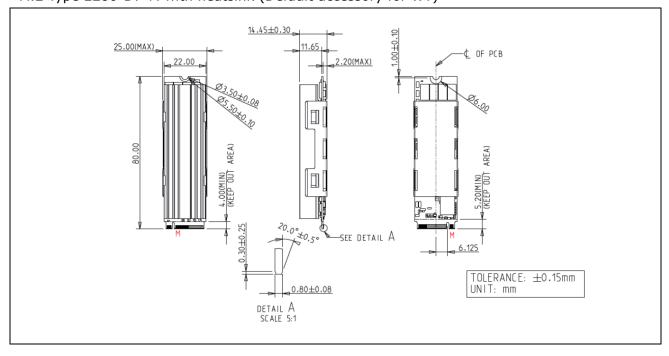


Figure 4: Innodisk M.2 (P80) 4TG2-P with iCell



M.2 Type 2280-D7-M

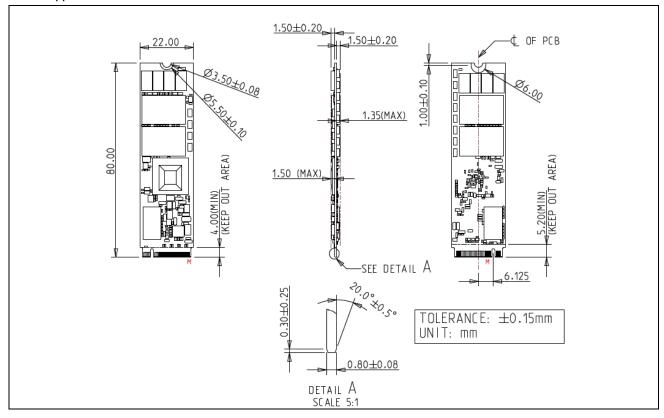


Figure 5: Innodisk M.2 (P80) 4TG2-P with iCell

2.11 Assembly Weight

An Innodisk M.2 (P80) 4TG2-P within NAND flash ICs, 512GB's weight is 7 grams approximately.

2.12 Seek Time

Innodisk M.2 (P80) 4TG2-P is not a magnetic rotating design. There is no seek or rotational latency required.

2.13 NAND Flash Memory

Innodisk M.2 (P80) 4TG2-P uses 3D TLC NAND flash memory, which is non-volatility, high reliability and high speed memory storage.



3. Theory of Operation

3.1 Overview

Figure 6 shows the operation of Innodisk M.2 (P80) 4TG2-P from the system level, including the major hardware blocks.

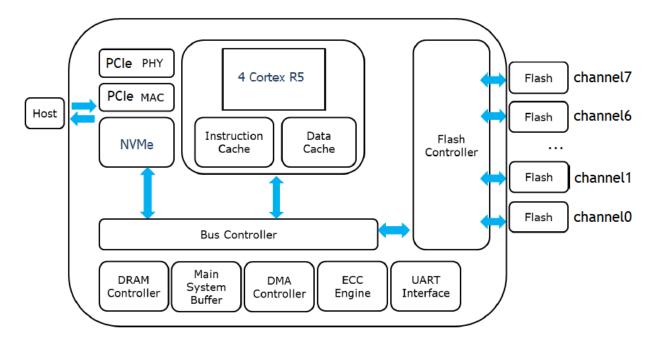


Figure 6: Innodisk M.2 (P80) 4TG2-P Block Diagram

Innodisk M.2 (P80) 4TG2-P integrates a PCIe Gen IV x4 controller and NAND flash memories. Communication with the host occurs through the host interface, using the standard NVM protocol. Communication with the flash device(s) occurs through the flash interface.

3.2 PCIe Gen. 4 x4 Controller

Innodisk M.2 (P80) 4TG2-P is a PCIe Gen. 4x4 controller is compliant with NVMe 1.4, up to 32.0Gbps transfer speed. Also it is compliant with PCIe Gen. 1, Gen. 2, Gen. 3 and Gen. 4 specification. The controller supports up to 8 channels for flash interface.

3.3 Error Detection and Correction

Innodisk M.2 (P80) 4TG2-P is designed with hardware LDPC ECC engine with hard-decision and soft-decision decoding. Low-density parity-check (LDPC) codes have excellent error correcting performance close to the Shannon limit when decoded with the belief-propagation (BP) algorithm using soft-decision information.



3.4 Wear-Leveling

Flash memory can be erased within a limited number of times. This number is called the **erase cycle limit** or **write endurance limit** and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

Innodisk M.2 (P80) 4TG2-P uses a combination of two types of wear leveling- dynamic and static wear leveling- to distribute write cycling across an SSD and balance erase count of each block, thereby extending flash lifetime.

3.5 Bad Blocks Management

Bad Blocks are blocks that contain one or more invalid bits whose reliability are not guaranteed. The Bad Blocks may be presented while the SSD is shipped, or may develop during the life time of the SSD. When the Bad Blocks is detected, it will be flagged, and not be used anymore. The SSD implement Bad Blocks management, Bad Blocks replacement, Error Correct Code to avoid data error occurred. The functions will be enabled automatically to transfer data from Bad Blocks to spare blocks, and correct error bit.

3.6 iData Guard

Innodisk's iData Guard is a comprehensive data protection mechanism that functions before and after a sudden power outage to the SSD. Low-power detection terminates data writing before an abnormal power-off, while table-remapping after power-on deletes corrupt data and maintains data integrity. Innodisk's iData Guard provides effective power cycling management, preventing data stored in flash from degrading with use.

3.7 Garbage Collection/TRIM

Garbage collection and TRIM technology is used to maintain data consistency and perform continual data cleansing on SSDs. It runs as a background process, freeing up valuable controller resources while sorting good data into available blocks, and deleting bad blocks. It also significantly reduces write operations to the drive, thereby increasing the SSD's speed and lifespan.

3.8 Thermal Management

M.2 (P80) 4TG2-P has built-in thermal sensor which can detect environment temperature of SSD. In the meantime, firmware will monitor the thermal sensor to prevent any failure of overheating. During extreme temperature, firmware will adjust the data transfer behavior to maintain the SSD's reliable operation.



3.9 Thermal Throttling

Thermal throttling is a protective mechanism designed to safeguard components from potential damage caused by excessive temperatures. When an SSD approaches a critical temperature threshold, Innodisk firmware activates the thermal throttling mechanism to regulate the SSD's temperature. Thermal throttling is crucial for SSDs since it prevents drive damage, which could otherwise result in data loss. However, it's worth noting that when thermal throttling is activated, read and write tasks may experience a reduction in speed.

3.10 Die RAID

Die RAID is a controller function which leveraged user capacity to back up the data in NAND flash. Die RAID supported can ensure the user data in the NAND Flash more consistent in certain scenario. Innodisk M.2 (P80) 4TG2-P series is default enable the Die RAID function for the industrial application.

3.11 SLC Cache

4TG2-P series adopt hybrid mode which enables SLC Cache up to 3% of full disk capacity followed by TLC direct write to strike balance between burst performance and steady overall stability. The SLC Cache buffer size are defined as table below.

Table 12: M.2 (P80) 4TG2-P SLC cache

Capacity	512GB	1TB	2ТВ
SLC cache (GB)	15.36	30.72	61.44
SLC cache (%)	3	3	3

3.12 iCell Technology

iCell circuit is designed with several capacitors to be able to provide power after host power off. The SSD controller can write all DRAM buffer data to flash, so that is why M.2 (P80) 4TG2-P can ensure all data can be written to disk without any data loss.



4. Installation Requirements

4.1 M.2 (P80) 4TG2-P Pin Directions

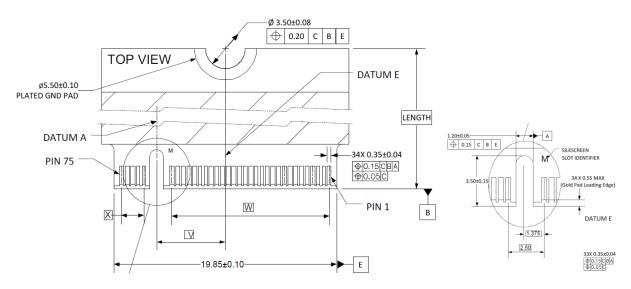


Figure 7: Signal Segment and Power Segment

4.2 Electrical Connections for M.2 (P80) 4TG2-P

M.2 interconnect is based on a 75 position Edge Card connector. The 75 position connector is intended to be keyed so as to distinguish between families of host interfaces and the various Sockets used in general Platforms. M.2 (P80) 4TG2-P is compliant with M.2 Socket 3 key M. M.2 (P80) 4TG2-P is compatible with host connector H4.2.

4.3 Device Drive

M.2 (P80) 4TG2-P is compliant with NVMe 1.4. Both Operation System and BIOS should include NVMe driver to compatible with NVMe device. Nowadays, most of OS includes NVMe in-box driver now. For more information about the driver support in each OS, please visit the website https://nvmexpress.org/drivers/. For BIOS NVMe driver support please contact with motherboard manufacture.



5. SMART / Health Information

This log page is used to provide SMART and general health information. The information provided is over the life of the controller and is retained across power cycles. More details about Set Features command; please refer to NVM Express 1.3

5.1 Get Log Page (Log Identifier 02h)

Innodisk 4TG2-P series SMART / Health Information Log are listed in following table.

Table 13: Get Log Page - SMART / Health Information Log

Bytes	Description					
0	Critical Warning: This field indicates critical warnings for the state of the controller. Each					
	bit correspo	bit corresponds to a critical warning type; multiple bits may be set. If a bit is cleared to '0',				
	then that ci	ritical warning does not apply. Critical warnings may result in an asynch	nronou			
	event notifi	event notification to the host. Bits in this field represent the current associated state and				
	are not per	sistent.				
	Bit	Definition				
	00	If set to '1', then the available spare space has fallen below the threshold.				
	01	If set to '1', then a temperature is above an over temperature threshold or below an under temperature threshold.				
	02	If set to '1', then the NVM subsystem reliability has been degraded due to significant media related errors or any internal error that degrades NVM subsystem reliability.				
	03	If set to '1', then the media has been placed in read only mode.				
	04	If set to '1', then the volatile memory backup device has failed. This field is only valid if the controller has a volatile memory backup solution.				
	07:05	Reserved				
2:1		Temperature: Contains a value corresponding to a temperature in	degree			
2.1	Kelvin that namespace is implement point in the asynchronous	Kelvin that represents the current composite temperature of the controller and namespace(s) associated with that controller. The manner in which this value is computed is implementation specific and may not represent the actual temperature of any physical point in the NVM subsystem. The value of this field may be used to trigger an asynchronous event. Warning and critical overheating composite temperature threshold values are reported				
		EMP and CCTEMP fields in the Identify Controller data structure.	CP.			



3	Available Spare: Contains a normalized percentage (0 to 100%) of the remaining spare capacity available.
4	Available Spare Threshold: When the Available Spare falls below the threshold indicated in this field, an asynchronous event completion may occur. The value is indicated as a normalized percentage (0 to 100%).
5	Percentage Used: Contains a vendor specific estimate of the percentage of NVM subsystem life used based on the actual usage and the manufacturer's prediction of NVM life. A value of 100 indicates that the estimated endurance of the NVM in the NVM subsystem has been consumed, but may not indicate an NVM subsystem failure. The value is allowed to exceed 100. Percentages greater than 254 shall be represented as 255. This value shall be updated once per power-on hour (when the controller is not in a sleep state). Refer to the JEDEC JESD218A standard for SSD device life and endurance measurement
	techniques.
31:6	Reserved
47:32	Data Units Read: Contains the number of 512 byte data units the host has read from the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes read) and is rounded up. When the LBA size is a value other than 512 bytes, the controller shall convert the amount of data
	read to 512 byte units. For the NVM command set, logical blocks read as part of Compare and Read operations shall be included in this value.
63:48	Data Units Written: Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes written) and is rounded up. When the LBA size is a value other than 512 bytes, the controller shall convert the amount of data written to 512 byte units. For the NVM command set, logical blocks written as part of Write operations shall be included in this value. Write Uncorrectable commands shall not impact this value.
79:64	Host Read Commands: Contains the number of read commands completed by the controller. For the NVM command set, this is the number of Compare and Read commands.
95:80	Host Write Commands: Contains the number of write commands completed by the controller. For the NVM command set, this is the number of Write commands.
111:96	Controller Busy Time: Contains the amount of time the controller is busy with I/O commands. The controller is busy when there is a command outstanding to an I/O Queue (specifically, a command was issued via an I/O Submission Queue Tail doorbell write and the corresponding completion queue entry has not been posted yet to the associated I/O Completion Queue). This value is reported in minutes.



127:112	Power Cycles: Contains the number of power cycles.									
143:128	Power On Hours: Contains the number of power-on hours. This may not include time that									
	the controller was powered and in a non-operational power state.									
159:144	Unsafe Shutdowns: Contains the number of unsafe shutdowns. This count is incremented									
	when a shutdown notification (CC.SHN) is not received prior to loss of power.									
175:160	Media and Data Integrity Errors: Contains the number of occurrences where the									
	controller detected an unrecovered data integrity error. Errors such as uncorrectable ECC,									
	CRC checksum failure, or LBA tag mismatch are included in this field.									
191:176	Number of Error Information Log Entries: Contains the number of Error Information log									
	entries over the life of the controller.									
195:192	Warning Composite Temperature Time: Contains the amount of time in minutes that the									
	controller is operational and the Composite Temperature is greater than or equal to the									
	Warning Composite Temperature Threshold (WCTEMP) field and less than the Critical									
	Composite Temperature Threshold (CCTEMP) field in the Identify Controller data									
	structure.									
	If the value of the WCTEMP or CCTEMP field is 0h, then this field is always cleared to 0h									
	regardless of the Composite Temperature value.									
199:196	Critical Composite Temperature Time: Contains the amount of time in minutes that the									
	controller is operational and the Composite Temperature is greater than the Critical									
	Composite Temperature Threshold (CCTEMP) field in the Identify Controller data									
	structure.									
	If the value of the CCTEMP field is 0h, then this field is always cleared to 0h regardless of									
201,200	the Composite Temperature value.									
201:200	Temperature Sensor 1: Controller's Tj temperature									
203:202	Temperature Sensor 2: Flash package's Tj temperature (Channel #0 CE #0). This Flash									
	package is located the closet to the controller IC on M.2 family.									
205:204	Temperature Sensor 3: Flash package's Tj temperature (Channel #0 CE #0).									
	This Flash package is located the closet to the controller IC on M.2 family.									
207:206	Temperature Sensor 4: Flash package's Tj temperature (Channel #7 CE #0).									
209:208	Temperature Sensor 5: Flash Tj max temperature from Channel #0 to Channel #3 Flash									
	packages.									
211:210	Temperature Sensor 6: Flash Tj max temperature from Channel #4 to Channel #7 Flash									
	packages.									
213:212	Temperature Sensor 7: Flash Tj minimum temperature from Channel #0 to Channel #3									
	Flash packages.									
215:214	Temperature Sensor 8: Flash Tj minimum temperature from Channel #4 to Channel #7									
	Flash packages.									
219:216	Thermal Management Temperature 1 Transition Count: Contains the number of times									



	the controller transitioned to lower power active power states or performed vendor										
	specific thermal management actions while minimizing the impact on performance in										
	order to attempt to reduce the Composite Temperature because of the host controlled										
	thermal management feature (refer to section 8.4.5) (i.e., the Composite Temperature										
	rose above the Thermal Management Temperature 1.) This counter shall not wrap once										
	it reaches its maximum value. A value of zero, indicates that this transition has never										
	occurred or this field is not implemented.										
223:220	Thermal Management Temperature 2 Transition Count: Contains the number of times										
	the controller transitioned to lower power active power states or performed vendor										
	specific thermal management actions regardless of the impact on performance (e.g.,										
	heavy throttling) in order to attempt to reduce the Composite Temperature because of										
	the host controlled thermal management feature (refer to section 8.4.5) (i.e., the										
	Composite Temperature rose above the Thermal Management Temperature 2.) This										
	counter shall not wrap once it reaches its maximum value. A value of zero, indicates that										
	this transition has never occurred or this field is not implemented.										
227:224	Total Time For Thermal Management Temperature 1: Contains the number of seconds										
	that the controller had transitioned to lower power active power states or performed										
	vendor specific thermal management actions while minimizing the impact on										
	performance in order to attempt to reduce the Composite Temperature because of the										
	host controlled thermal management feature (refer to section 8.4.5). This counter shall										
	not wrap once it reaches its maximum value. A value of zero, indicates that this transition										
	has never occurred or this field is not implemented.										
231:228	Total Time For Thermal Management Temperature 2: Contains the number of seconds										
	that the controller had transitioned to lower power active power states or performed										
	vendor specific thermal management actions regardless of the impact on performance										
	(e.g., heavy throttling) in order to attempt to reduce the Composite Temperature because										
	of the host controlled thermal management feature (refer to section 8.4.5). This counter										
	shall not wrap once it reaches its maximum value. A value of zero, indicates that this										
	transition has never occurred or this field is not implemented.										
511:232	Reserved										

The innodisk M.2 (P80) series thermal sensor take ambient air temperature as a reference with any airflow condition, and the data can refer to iSMART.

Notes: More detailed health info has been defined by innodisk and will be shown on iSMART V5.3.21 (or later version).



6. Part Number Rule

COD	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21
E	D	G	М	2	8	-	С	1	2	D	P	1	K	С	D	E	F	Р	1	x	x

	U	G	141	2	0		J	_		U		_	ĸ	ر	ט	L		P	_	^	^	
									De	efir	itio	n										
			Co	de 1	st (D	isk)					Code 14 th (Operation Temperature)											
D : Dis	sk										C: Standard Grade (0 $^{\circ}$ C ~ +70 $^{\circ}$ C)											
	W: Industrial Grade (-40°C ~ +85°C)																					
G : EverGreen Series																						
Code 3 rd ~5 th (Form factor)												Code 15 th (Internal control)										
M28: N	ч .2 Т	Гуре	2280)-D7	-M						A∼Z:	BGA	PCE	3 ver	sion							
		Cod	le 7 ^t	^h ∼9	th (C	apa	city))			Code 16 th (Channel of data transfer)											
C12: 5	12G	В	01	Г: 1Т	В		02T:	2TE	3		E: Eight Channels											
	С	ode	10 th	~12	2 th ((Cont	rolle	er)			Code 17 th (Flash Type)											
DP1: P	CIe	4TG2	2-P s	eries	;						F: Koxia 3D TLC											
		Cod	de 13	3 th (Flas	h mo	ode)				Code 18 th (Optional function)											
K: 3D	TLC	112	layer	s							P: iCell feature											
											PH: iCell feature + Heatsink											
										Code 20 th ~ (Customize code)												